Advanced Automation based on Standards

How other industries can profit from automation concepts in semiconductor manufacturing

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Agenda

- Advanced automation in semiconductor manufacturing why?
- Standards & automation concept
- Potential for other industries
- The chance of working together



Advanced automation in semiconductor manufacturing

... what comes to mind





Advanced automation in semiconductor manufacturing

Economic leverage of semiconductor value chain





Advanced automation in semiconductor manufacturing

The productivity gap



Time



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Standards Some history

Most famous standard: "SECS/GEM"

- 1978: Hewlett-Packard proposed that standards be established for communications among semiconductor manufacturing equipment.
- 1980/1982: SEMI published the SECS-1/SECS-II standards
- 1992: GEM standard published
- Continued: HSMS, GEM300,
 EDA/Interface A, …





Standards SEMI S8 – Safety Examples **Guidelines for Ergonomics: SEMI E72 Equipmen** SEMI E30 (GE Hand clearance footprint example beha Minimum 76 mm des all (3.0 in.) the tool) rear user **SEMI E95 – Specification for Human Interface:** 114 interface ABORTE **Title Panel** utilities supply 16 access door 113 swing-out-ABORTIN E15.1-compliant 14 load ports and **Command Pane** carrier buffers-CHECKING Information Panel front user 117 interface _ PAU possible wall 33 34 20 locations, if any (see SEMI 15.1) PAUSED 22 load face plane 116 of the tool ALARN Navigation Panel PAUSE 13 UN 15 112 Minimum 890 mm STOPPING (35 in.) 12 **PROCESSING ACTIVE** 🗾 Fraunhofer



Referring to: <u>http://www.semi.org/en/sites/semi.org/files/docs/AUX023-00-1211.pdf</u> (15.03.2012)



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Categories of SEMI standards

- 3D-IC (3D)
- Equipment Automation Hardware (E)
- Equipment Automation Software (E)
- Facilities (F)
- Flat Panel Display (D)
- Gases (C)
- HB-LED (HB)
- Materials (M)
- MEMS (MS)
- Microlithography (P)

Packaging (G)

- Photovoltaic (PV)
 - Process Chemicals (C)
 - Safety Guidelines (S)
 - Silicon Materials & Process Control (MF)
 - Traceability (T)

For other industries:

"Put everything to the test. Hold on to what is good."

(The Bible)



"Big data" and Advanced Process Control

- Objective: Ensure high quality productivity
- Fundamental goals of APC
 - to obtain measures for process control closer to the process
 - to automate control actions
- Typical APC methods (SEMI E133):
 - SPC, FDC, FP, RtR, VM, PdM
- Basis for APC:
 - Metrology data
 - Data from equipment & processes
 - Logistics data









Examples for productivity enhancement by APC

Real-time control of plasma processes by integrated OES







Examples for productivity enhancement by APC

Prediction of maintenance events by PdM







broken

Examples for productivity enhancement by APC

From an ENIAC project on productivity enhancement - IMPROVE

- 9 European Semiconductor manufacturing sites
- Requirement: Integration by utilizing standards!
- Generic framework based on SEMI standards
- Increase of equipment availability in the range of 1%-5%
- Equipment Health Factor (EHF) and the capability to predict equipment failure improve the cycle time by reducing unexpected failure.
- Knowledge of equipment behavior from the modelling work provided a better diagnosis capability and therefore an additional improvement of the equipment availability in the range of 1%.





Lessons learned from APC in semiconductor manufacturing

- 1. Know your process
- 2. Make use of standards
- 3. Use data you already have
- 4. Take care of data quality
- 5. Keep things simple and inexpensive
- 6. Go for low-hanging fruits







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Results from a study amongst German IC manufacturers

Main challenge:

How to enhance productivity in a "More than Moore" production environment!





Results from a study amongst German IC manufacturers





Starting points towards "Industry 4.0"





Starting points towards "Industry 4.0"





A semiconductor view on "Industry 4.0"

In Semiconductor FrontEnd factories elements of a "Smart Factory" are already realized.



Dr. T. Kaufmann, Infineon

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Summary

Achievements in semiconductor manufacturing

- Standards and automation concepts evolved over more than 35 years
- Proven as basis for improved productivity

Potential for other industries

- "Hold on to what is good" knowledge and definitions
- Well experienced R&D and suppliers available

The chance of working together

- From APC-enhanced equipment to cyber-physical systems
- Semiconductor manufacturing: strategic partnerships with other industries, spearheading with products and "manufacturing science"



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Thanks for your attention!

